

AO4437

P-Channel Enhancement Mode Field Effect Transistor



General Description

The AO4437 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected. Standard Product AO4437 is Pb-free (meets ROHS & Sony 259 specifications). AO4437L is a Green Product ordering option. AO4437 and AO4437L are electrically identical.

Features

 $V_{DS}(V) = -12V$

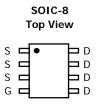
 $I_D = -11 \text{ A } (V_{GS} = -4.5 \text{V})$

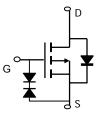
 $R_{DS(ON)} < 16m\Omega (V_{GS} = -4.5V)$

 $R_{DS(ON)}$ < 20m Ω (V_{GS} = -2.5V)

 $R_{DS(ON)}$ < 25m Ω (V_{GS} = -1.8V)

ESD Rating: 4KV HBM





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-12	V				
Gate-Source Voltage		V_{GS}	±8	V				
Continuous Drain	T _A =25°C		-11					
Current ^A	T _A =70°C	I _D	-9	A				
Pulsed Drain Current ^B		I _{DM}	-20					
	T _A =25°C	В	3	W				
Power Dissipation ^A	T _A =70°C	$-P_D$	2.1	T vv				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient A	t ≤ 10s	В	31	40	°C/W				
Maximum Junction-to-Ambient A	Steady-State	dy-State R _{θJA}		75	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Тур	Max	Units
STATIC I	PARAMETERS					
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-12			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-9.6V, V _{GS} =0V			-1	μА
		T _J =55°C			-5	μΑ
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±4.5V			±1	μΑ
		V_{DS} =0V, V_{GS} =±8V			±10	μΑ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$		-0.55	-1	
$I_{D(ON)}$	On state drain current	V_{GS} =-4.5V, V_{DS} =-5V	-20			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-4.5V, I _D =-11A		12.4	16	mΩ
		T _J =125°C		17	21	
		V_{GS} =-2.5V, I_{D} =-10A		15.9	20	mΩ
		V_{GS} =-1.8V, I_D =-6A		20.4	25	mΩ
g FS	Forward Transconductance	e V_{DS} =-5V, I_D =-11A		38		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.74	-1	V
I_S	Maximum Body-Diode Continuous Current				-4.5	Α
DYNAMI	CPARAMETERS					
C_{iss}	Input Capacitance			3960	4750	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-6V, f=1MHz		910		pF
C _{rss}	Reverse Transfer Capacitance			757		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		6.9	8.5	Ω
SWITCH	NG PARAMETERS					
Q_g	Total Gate Charge			37	47	nC
Q_{gs}	Gate Source Charge	V_{GS} =-4.5V, V_{DS} =-6V, I_{D} =-11A		4.5		nC
Q_{gd}	Gate Drain Charge			11		nC
t _{D(on)}	Turn-On Delay Time			15		ns
t _r	Turn-On Rise Time	V_{GS} =-4.5V, V_{DS} =-6V, R_L =0.55 Ω ,		43		ns
t _{D(off)}	Turn-Off Delay Time	$R_{GEN}=3\Omega$		158		ns
t _f	Turn-Off Fall Time			95		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-11A, dI/dt=100A/μs		64		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-11A, dI/dt=100A/μs		50		nC

A: The value of $R_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

Rev2: August 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE

B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta,IA}$ is the sum of the thermal impedence from junction to lead $R_{\theta,II}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

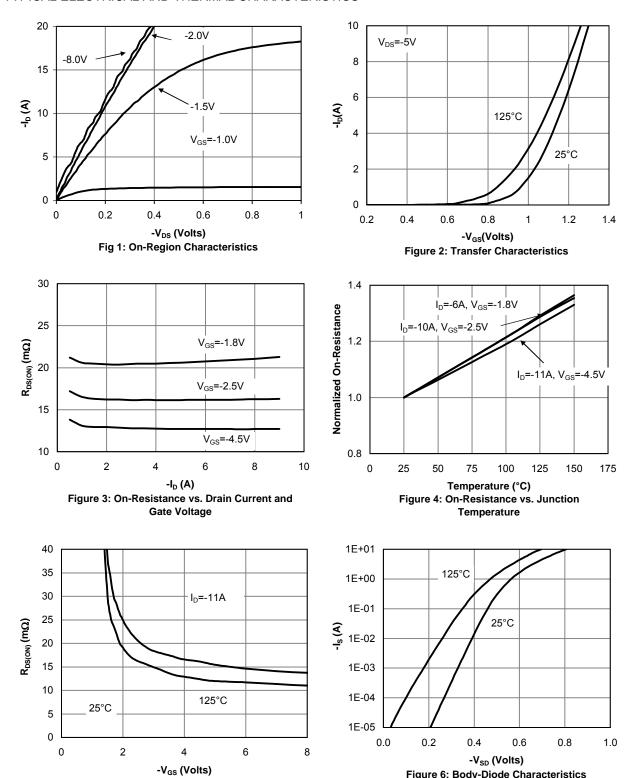


Figure 6: Body-Diode Characteristics

Figure 5: On-Resistance vs. Gate-Source Voltage